



Applications

- PV inverters
- UPS
- High speed motor drives
- Induction heating
- Welding
- Aerospace power converters
- Medical imaging amplifiers
- Electric vehicle
- Boost converters

Product Advantages

- Significant reduction in switching losses
- Increased system efficiency
- High temperature operation
- Higher operating frequency
- Reduced cooling requirements
- Low parasitic inductance
- Reduced system size / high power density



Next Generation of Power Semiconductors using Mitsubishi Silicon Carbide

RóHS

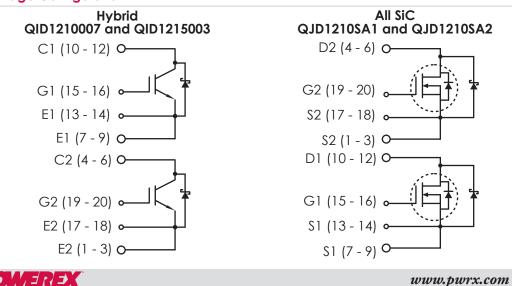
Overview

Large bandgap energy and high field breakdown are two primary characteristics of silicon carbide (SiC) which have been leveraged to create a new generation of power semiconductors with zero reverse recovery charge, significantly lower switching losses and the opportunity for higher temperature operation.

Powerex packages SiC MOSFETs and Schottky barrier diodes from Mitsubishi into high performance all SiC modules or with high frequency silicon IGBTs into hybrid Si / SiC modules. The new low profile split dual package features low inductance and either a standard copper or AlSiC baseplate for high thermal cycling applications.

Diodes in both the MOSFET or hybrid version are Mitsubishi Silicon Carbide (SiC) Schottky diode chips.

Package Configuration



Serving Our Customers Through Expertise, Innovation and Reliability

Line-up Table

Part Number	Package Configuration	V _{CES} (V)	I _C (A)
plit Dual Hybrid Si / SiC QID1210007 - Cu Baseplate QID1215003 - Cu Baseplate	Split Dual Split Dual	1200 1200	100 150
All SiC QJD1210SA1 - Cu Baseplate QJD1210SA2 - AlSiC Baseplate eatures	Split Dual MOSFET Split Dual MOSFET	1200 1200	100 100
 QID1210007, QID1215003 Low ESW(off) Aluminum Nitride Isolation Discrete Super-Fast Recovery Free-Wheel Silicon Carbide Schottky Diode, 75A or 150A High Frequency Silicon from Mitsubishi using NFH IGBT Technology Automated Assembly Assures High Reliability Low Internal Inductance 2 Individual Switches per Module Isolated Baseplate for Easy Heat Sinking AlSiC Baseplate Available 	 QJD1210SA1, QJD12 Low Internal Inductar Industry Leading RDS High Speed Switching Low Switching Losses Low Capacitance Low Drive Requireme Fast 75A Free Wheeling Schottky Diode High Power Density Isolated Baseplate Aluminum Nitride Isola 2 Individual Switches per Module RoHS Compliant 	nce (on) g nt ng	



109.9mm x 56.1mm



